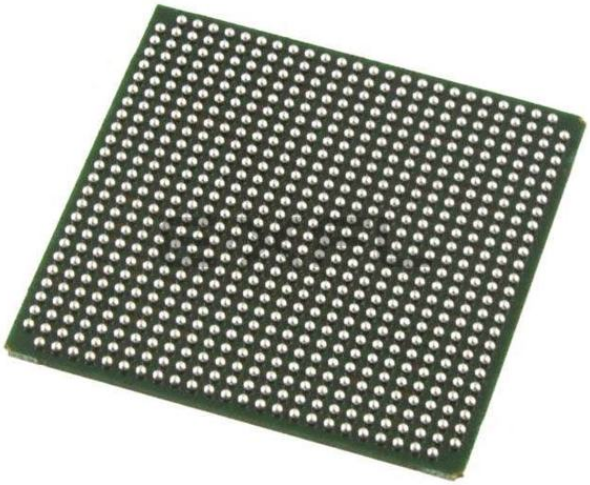


Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

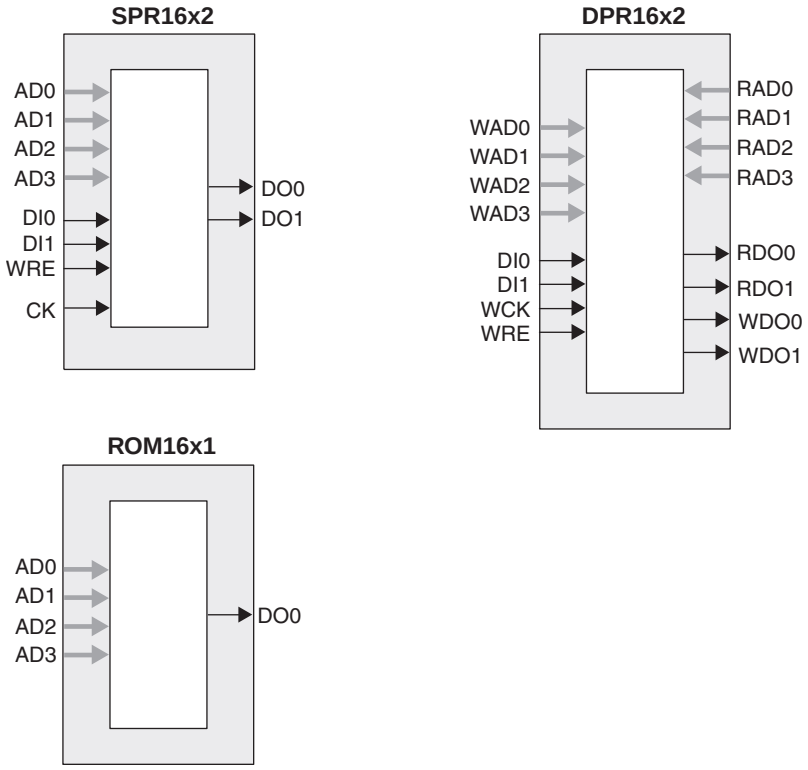
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	19700
Total RAM Bits	434176
Number of I/O	400
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec20e-5f672c

Figure 2-5. Distributed Memory Primitives



ROM Mode: The ROM mode uses the same principal as the RAM modes, but without the Write port. Pre-loading is accomplished through the programming interface during configuration.

PFU Modes of Operation

Slices can be combined within a PFU to form larger functions. Table 2-4 tabulates these modes and documents the functionality possible at the PFU level.

Table 2-4. PFU Modes of Operation

Logic	Ripple	RAM[1]	ROM
LUT 4x8 or MUX 2x1 x 8	2-bit Add x 4	SPR16x2 x 4 DPR16x2 x 2	ROM16x1 x 8
LUT 5x4 or MUX 4x1 x 4	2-bit Sub x 4	SPR16x4 x 2 DPR16x4 x 1	ROM16x2 x 4
LUT 6x 2 or MUX 8x1 x 2	2-bit Counter x 4	SPR16x8 x 1	ROM16x4 x 2
LUT 7x1 or MUX 16x1 x 1	2-bit Comp x 4		ROM16x8 x 1

1. These modes are not available in PFF blocks

Table 2-5. PLL Signal Descriptions

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	PLL feedback input from CLKOP (PLL internal), from clock net (CLKOP) or from a user clock (PIN or logic)
RST	I	"1" to reset PLL
CLKOS	O	PLL output clock to clock tree (phase shifted/duty cycle changed)
CLKOP	O	PLL output clock to clock tree (No phase shift)
CLKOK	O	PLL output to clock tree through secondary clock divider
LOCK	O	"1" indicates PLL LOCK to CLKI
DDAMODE	I	Dynamic Delay Enable. "1": Pin control (dynamic), "0": Fuse Control (static)
DDAIZR	I	Dynamic Delay Zero. "1": delay = 0, "0": delay = on
DDAILAG	I	Dynamic Delay Lag/Lead. "1": Lead, "0": Lag
DDAIDEL[2:0]	I	Dynamic Delay Input
DDAOZR	O	Dynamic Delay Zero Output
DDAOLAG	O	Dynamic Delay Lag/Lead Output
DDAODEL[2:0]	O	Dynamic Delay Output

For more information about the PLL, please see the list of technical documentation at the end of this data sheet.

Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved regardless of where the select signal is toggled. There are eight DCS blocks per device, located in pairs at the center of each side. Figure 2-13 illustrates the DCS Block Macro.

Figure 2-13. DCS Block Primitive

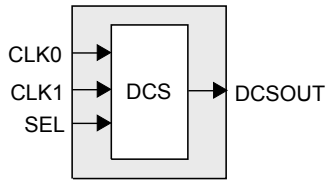


Figure 2-14 shows timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of technical documentation at the end of this data sheet.

Table 2-7. Maximum Number of Elements in a Block

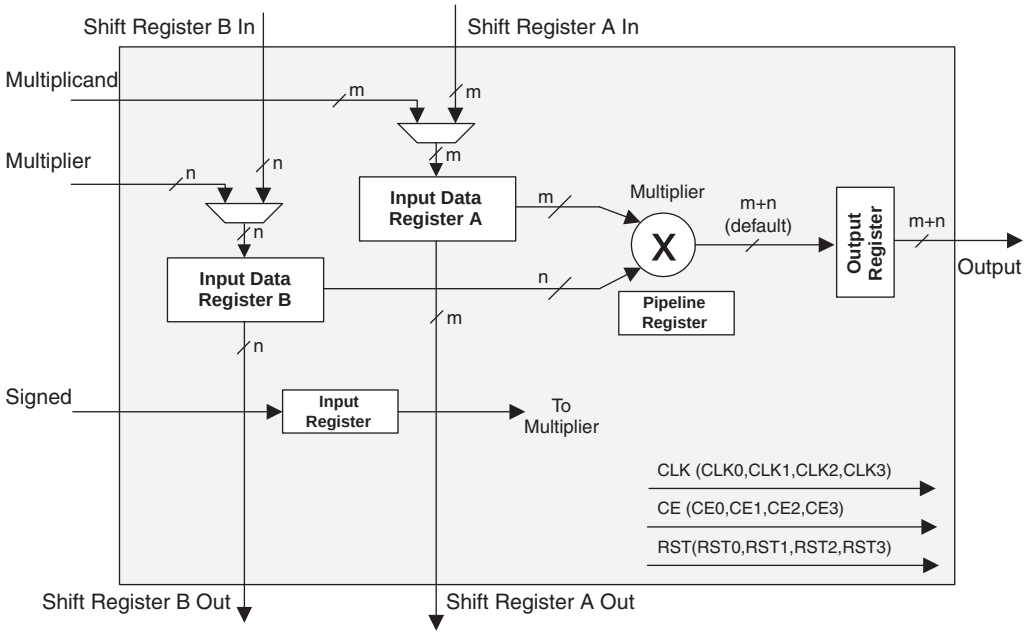
Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADD	4	2	—
MULTADDSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as shift registers from previous operand registers. In addition by selecting “dynamic operation” in the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle. Similarly by selecting ‘Dynamic operation’ in the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-19 shows the MULT sysDSP element.

Figure 2-19. MULT sysDSP Element



MAC sysDSP Element

In this case the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers but the output register is always enabled. The output register is used to store the accumulated value. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-20 shows the MAC sysDSP element.

Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

Table 2-8. An Example of Sign Extension

Number	Unsigned	Unsigned 9-bit	Unsigned 18-bit	Signed	Two's Complement Signed 9-Bits	Two's Complement Signed 18-bits
+5	0101	000000101	000000000000000101	0101	000000101	000000000000000101
-6	0110	000000110	000000000000000110	1010	111111010	111111111111111010

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number then accumulator roll over is said to occur and overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator "roll-over" is said to have occurred and an overflow signal is indicated. Note when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-23.

Figure 2-23. Accumulator Overflow/Underflow Conditions

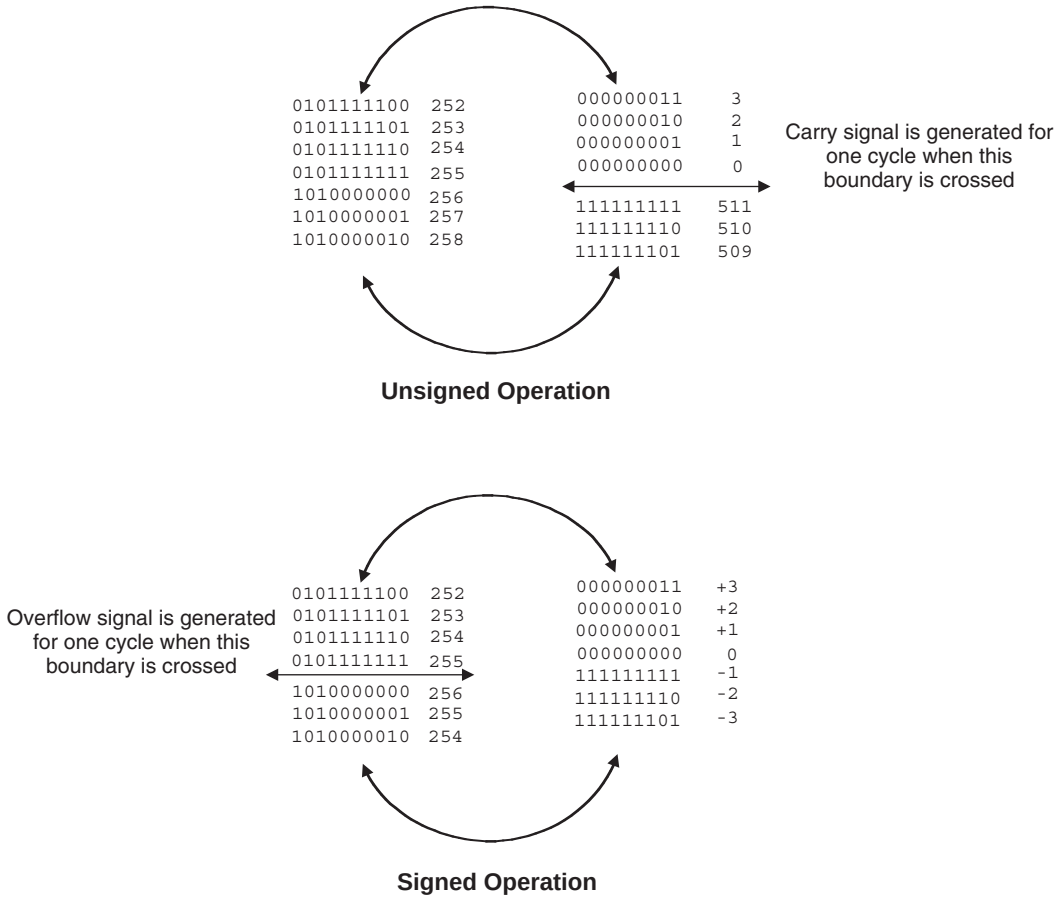


Figure 2-27. Input Register DDR Waveforms

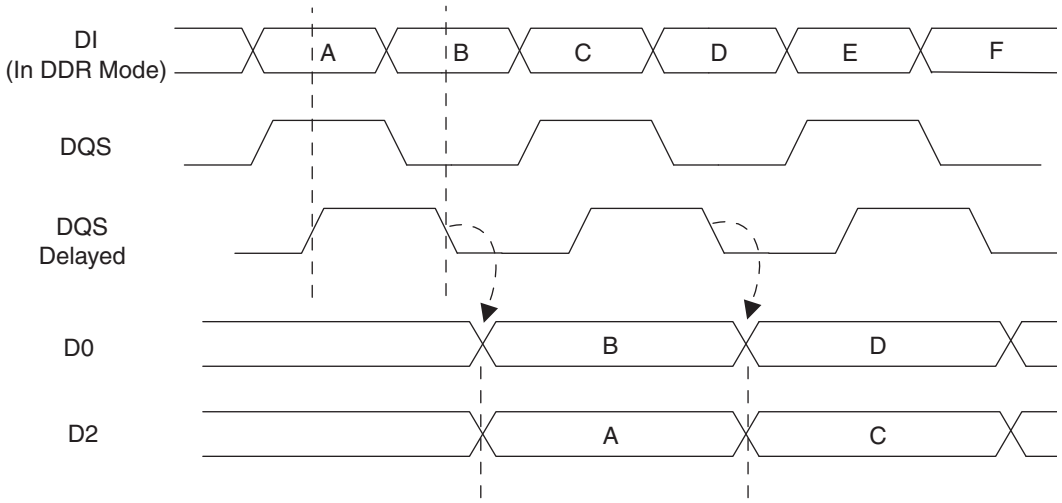
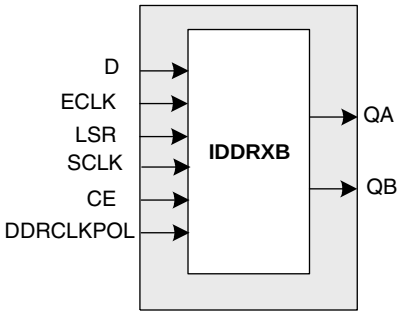


Figure 2-28. INDDRXB Primitive



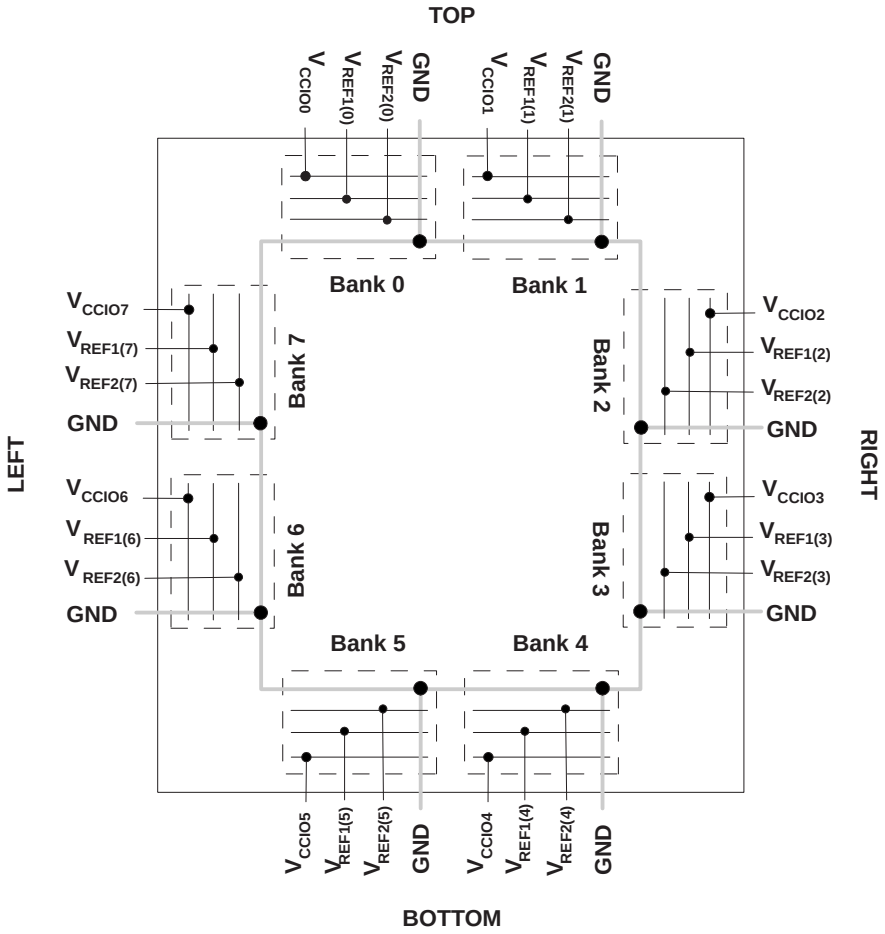
Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The block contains a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-29 shows the diagram of the Output Register Block.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG0 is fed into one register on the positive edge of the clock and OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

Figure 2-30 shows the design tool DDR primitives. The SDR output register has reset and clock enable available. The additional register for DDR operation does not have reset or clock enable available.

Figure 2-34. LatticeECP/EC Banks



LatticeECP/EC devices contain two types of sysI/O buffer pairs.

1. **Top and Bottom sysI/O Buffer Pairs (Single-Ended Outputs Only)**
   The sysI/O buffer pairs in the top and bottom banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

   The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

   Only the I/Os on the top and bottom banks have programmable PCI clamps. These I/O banks also support hot socketing with IDK less than 1mA. Note that the PCI clamp is enabled after V_{CC}, V_{CCAUX} and V_{CCIO} are at valid operating levels and the device has been configured.

2. **Left and Right sysI/O Buffer Pairs (Differential and Single-Ended Outputs)**
   The sysI/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. The referenced input buffer can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

   Only the left and right banks have LVDS differential output drivers. See the I_{DK} specification for I/O leakage current during power-up.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}[1]	Input or I/O Leakage	0 ð V_{IN} ð (V_{CCIO} - 0.2V)	—	—	10	µA
I_{IH}[1, 3]	Input or I/O High Leakage	(V_{CCIO} - 0.2V) ð V_{IH} ð 3.6V	—	—	40	µA
I_{PU}	I/O Active Pull-up Current	0 ð V_{IN} ð 0.7 V_{CCIO}	-30	—	-150	µA
I_{PD}	I/O Active Pull-down Current	V_{IL} (MAX) ð V_{IN} ð V_{IH} (MAX)	30	—	150	µA
I_{BHLS}	Bus Hold Low sustaining current	V_{IN} = V_{IL} (MAX)	30	—	—	µA
I_{BHHS}	Bus Hold High sustaining current	V_{IN} = 0.7V_{CCIO}	-30	—	—	µA
I_{BHLO}	Bus Hold Low Overdrive current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	150	µA
I_{BHLH}	Bus Hold High Overdrive current	0 ð V_{IN} ð V_{IH} (MAX)	—	—	-150	µA
V_{BHT}	Bus Hold trip Points	0 ð V_{IN} ð V_{IH} (MAX)	V_{IL} (MAX)	—	V_{IH} (MIN)	V
C1	I/O Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	8	—	pf
C2	Dedicated Input Capacitance[2]	V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = 1.2V, V_{IO} = 0 to V_{IH} (MAX)	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. T_A 25°C, f = 1.0MHz
3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO}, a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO}.

Derating Timing Tables

Logic Timing provided in the following sections of the data sheet and the ispLEVER design tools are worst-case numbers in the operating range. Actual delays at nominal temperature and voltage for best-case process, can be much better than the values given in the tables. To calculate logic timing numbers at a particular temperature and voltage multiply the noted numbers with the derating factors provided below.

The junction temperature for the FPGA depends on the power dissipation by the device, the package thermal characteristics (Θ_{JA}), and the ambient temperature, as calculated with the following equation:

$$T_{JMAX} = T_{AMAX} + (Power * \Theta_{JA})$$

The user must determine this temperature and then use it to determine the derating factor based on the following derating tables: T_J °C.

Table 3-5. Delay Derating Table for Internal Blocks

T_J °C Commercial	T_J °C Industrial	Power Supply Voltage		
		1.14V	1.2V	1.26V
—	-40	0.82	0.77	0.71
—	-25	0.82	0.76	0.71
0	20	0.89	0.83	0.78
25	45	0.93	0.87	0.81
85	105	1.00	0.94	0.89

Timing Diagrams

PFU Timing Diagrams

Figure 3-6. Slice Single/Dual Port Write Cycle Timing

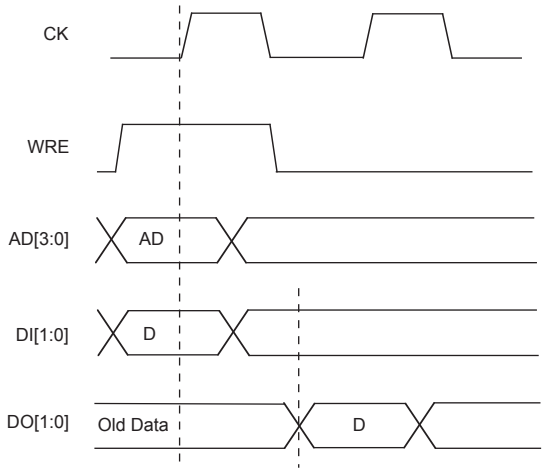
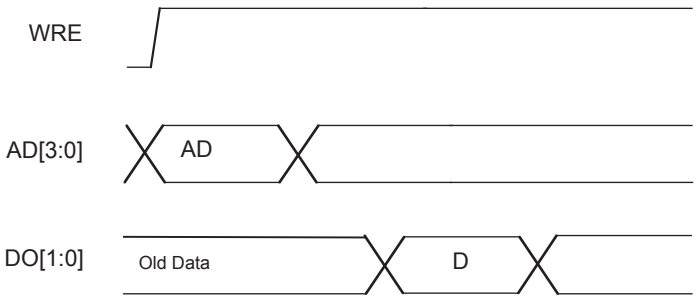


Figure 3-7. Slice Single /Dual Port Read Cycle Timing



Pin Information Summary

Pin Type		LFEC1			LFEC3				LFECP6/EC6				LFECP/EC10		
		100-TQFP	144-TQFP	208-PQFP	100-TQFP	144-TQFP	208-PQFP	256-fpBGA	144-TQFP	208-PQFP	256-fpBGA	484-fpBGA	208-PQFP	256-fpBGA	484-fpBGA
Single Ended User I/O		67	97	112	67	97	145	160	97	147	195	224	147	195	288
Differential Pair User I/O		29	46	56	29	46	72	80	46	72	97	112	72	97	144
Configuration	Dedicated	13	13	13	13	13	13	13	13	13	13	13	13	13	13
	Muxed	48	48	48	48	48	48	48	48	48	48	48	56	56	56
TAP		5	5	5	5	5	5	5	5	5	5	5	5	5	5
Dedicated (total without supplies)		80	110	160	80	110	160	208	110	160	208	373	160	208	373
V_{CC}		2	3	3	2	3	3	10	4	4	10	20	6	10	20
V_{CCAUX}		2	2	2	4	4	4	4	2	4	2	12	4	2	12
V_{CCPLL}		0	0	0	0	0	0	0	0	0	0	0	0	0	0
V_{CCIO}	Bank0	1	2	2	1	2	3	2	2	3	2	4	3	2	4
	Bank1	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank2	1	1	1	2	2	2	2	1	2	2	4	2	2	4
	Bank3	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank4	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank5	1	2	2	1	2	2	2	2	3	2	4	3	2	4
	Bank6	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank7	1	1	1	2	2	2	2	1	2	2	4	2	2	4
GND, GND0-GND7		8	13	13	8	13	16	20	14	18	20	44	20	20	44
NC		0	2	51	0	2	9	35	0	4	0	139	0	0	75
Single Ended/ Differential I/O Pair per Bank	Bank 0	11/5	14/7	16/8	11/5	14/7	26/13	32/16	14/7	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 1	11/5	13/6	16/8	11/5	13/6	16/8	16/8	13/6	17/8	18/9	32/16	17/8	18/9	32/16
	Bank 2	3/1	8/4	8/4	3/1	8/4	14/7	16/8	8/4	14/7	16/8	16/8	14/7	16/8	32/16
	Bank 3	8/4	13/6	16/8	8/4	13/6	16/8	16/8	13/6	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 4	12/4	14/6	16/8	12/4	14/6	16/8	16/8	14/6	17/8	17/8	32/16	17/8	17/8	32/16
	Bank 5	9/4	13/6	16/8	9/4	13/6	26/13	32/16	13/6	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 6	5/2	14/7	16/8	5/2	14/7	16/8	16/8	14/7	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 7	8/4	8/4	8/4	8/4	8/4	15/7	16/8	8/4	15/7	16/8	16/8	15/7	16/8	32/16
V_{CCJ}		1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
P14	PR35B	3	C		PR43B	3	C	
P15	PR35A	3	T		PR43A	3	T	
R15	PR34B	3	C		PR42B	3	C	
R16	PR34A	3	T		PR42A	3	T	
M13	PR33B	3	C		PR41B	3	C	
M14	PR33A	3	T	RDQS33	PR41A	3	T	RDQS41
P16	PR32B	3	C	RLM0_PLLC_FB_A	PR40B	3	C	RLM0_PLLC_FB_A
GND	GND3	3			GND3	3		
N16	PR32A	3	T	RLM0_PLLT_FB_A	PR40A	3	T	RLM0_PLLT_FB_A
N15	PR31B	3	C	RLM0_PLLC_IN_A	PR39B	3	C	RLM0_PLLC_IN_A
M15	PR31A	3	T	RLM0_PLLT_IN_A	PR39A	3	T	RLM0_PLLT_IN_A
M16	PR30B	3	C	DI/CSSPIN	PR38B	3	C	DI/CSSPIN
L16	PR30A	3	T	DOUT/CSON	PR38A	3	T	DOUT/CSON
K16	PR29B	3	C	BUSY/SISPI	PR37B	3	C	BUSY/SISPI
J16	PR29A	3	T	D7/SPID0	PR37A	3	T	D7/SPID0
L12	CFG2	3			CFG2	3		
L14	CFG1	3			CFG1	3		
L13	CFG0	3			CFG0	3		
K13	PROGRAMN	3			PROGRAMN	3		
L15	CCLK	3			CCLK	3		
K15	INITN	3			INITN	3		
K14	DONE	3			DONE	3		
GND	GND3	3			GND3	3		
H16	PR27B	3	C		PR31B	3	C	
-	-	-			GND3	3		
H15	PR27A	3	T		PR31A	3	T	
G16	PR26B	3	C		PR30B	3	C	
G15	PR26A	3	T		PR30A	3	T	
K12	PR25B	3	C		PR29B	3	C	
J12	PR25A	3	T		PR29A	3	T	
J14	PR24B	3	C		PR28B	3	C	
J15	PR24A	3	T	RDQS24	PR28A	3	T	RDQS28
F16	PR23B	3	C		PR27B	3	C	
GND	GND3	3			GND3	3		
F15	PR23A	3	T		PR27A	3	T	
J13	PR22B	3	C		PR26B	3	C	
H13	PR22A	3	T		PR26A	3	T	
H14	PR21B	3	C		PR25B	3	C	
G14	PR21A	3	T		PR25A	3	T	
E16	PR20B	3	C		PR24B	3	C	
E15	PR20A	3	T		PR24A	3	T	
H12	PR18B	2	C	PCLKC2_0	PR22B	2	C	PCLKC2_0
GND	GND2	2			GND2	2		

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
G9	GND	-			GND	-		
H10	GND	-			GND	-		
H7	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J10	GND	-			GND	-		
J7	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K7	GND	-			GND	-		
K8	GND	-			GND	-		
K9	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
E12	VCC	-			VCC	-		
E5	VCC	-			VCC	-		
E8	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M5	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
B15	VCCAUX	-			VCCAUX	-		
R2	VCCAUX	-			VCCAUX	-		
F7	VCCIO0	0			VCCIO0	0		
F8	VCCIO0	0			VCCIO0	0		
F10	VCCIO1	1			VCCIO1	1		
F9	VCCIO1	1			VCCIO1	1		
G11	VCCIO2	2			VCCIO2	2		
H11	VCCIO2	2			VCCIO2	2		
J11	VCCIO3	3			VCCIO3	3		
K11	VCCIO3	3			VCCIO3	3		
L10	VCCIO4	4			VCCIO4	4		
L9	VCCIO4	4			VCCIO4	4		
L7	VCCIO5	5			VCCIO5	5		
L8	VCCIO5	5			VCCIO5	5		
J6	VCCIO6	6			VCCIO6	6		
K6	VCCIO6	6			VCCIO6	6		
G6	VCCIO7	7			VCCIO7	7		
H6	VCCIO7	7			VCCIO7	7		
F6	VCC	-			VCC	-		
F11	VCC	-			VCC	-		
L11	VCC	-			VCC	-		
L6	VCC	-			VCC	-		

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
V2	PL41B	6	C	LLM0_PLLC_IN_A	V2	PL53B	6	C	LLM0_PLLC_IN_A
U3	PL42A	6	T	LLM0_PLLT_FB_A	U3	PL54A	6	T	LLM0_PLLT_FB_A
V3	PL42B	6	C	LLM0_PLLC_FB_A	V3	PL54B	6	C	LLM0_PLLC_FB_A
U4	PL43A	6	T		U4	PL55A	6	T	
V5	PL43B	6	C		V5	PL55B	6	C	
W1	PL44A	6	T		W1	PL56A	6	T	
GND	GND6	6			GND	GND6	6		
W2	PL44B	6	C		W2	PL56B	6	C	
Y1	PL45A	6	T	LDQS45	Y1	PL57A	6	T	LDQS57
Y2	PL45B	6	C		Y2	PL57B	6	C	
AA1	PL46A	6	T		AA1	PL58A	6	T	
AA2	PL46B	6	C		AA2	PL58B	6	C	
W4	PL47A	6	T		W4	PL59A	6	T	
V4	PL47B	6	C		V4	PL59B	6	C	
W3	PL48A	6	T	VREF1_6	W3	PL68A	6	T	VREF1_6
Y3	PL48B	6	C	VREF2_6	Y3	PL68B	6	C	VREF2_6
GND	GND6	6			GND	GND6	6		
GND	GND5	5			GND	GND6	6		
GND	-				GND	GND6	6		
GND	-				GND	GND5	5		
GND	GND5	5			GND	GND5	5		
V7	PB10A	5	T		V7	PB10A	5	T	
T6	PB10B	5	C		T6	PB10B	5	C	
V8	PB11A	5	T		V8	PB11A	5	T	
U7	PB11B	5	C		U7	PB11B	5	C	
W5	PB12A	5	T		W5	PB12A	5	T	
U6	PB12B	5	C		U6	PB12B	5	C	
AA3	PB13A	5	T		AA3	PB13A	5	T	
GND	GND5	5			GND	GND5	5		
AB3	PB13B	5	C		AB3	PB13B	5	C	
Y6	PB14A	5	T	BDQS14	Y6	PB14A	5	T	BDQS14
V6	PB14B	5	C		V6	PB14B	5	C	
AA5	PB15A	5	T		AA5	PB15A	5	T	
W6	PB15B	5	C		W6	PB15B	5	C	
Y5	PB16A	5	T		Y5	PB16A	5	T	
Y4	PB16B	5	C		Y4	PB16B	5	C	
AA4	PB17A	5	T		AA4	PB17A	5	T	
GND	GND5	5			GND	GND5	5		
AB4	PB17B	5	C		AB4	PB17B	5	C	
Y7	PB18A	5	T		Y7	PB18A	5	T	
W8	PB18B	5	C		W8	PB18B	5	C	
W7	PB19A	5	T		W7	PB19A	5	T	
U8	PB19B	5	C		U8	PB19B	5	C	
W9	PB20A	5	T		W9	PB20A	5	T	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
C22	PR9A	2	T	RUM0_PLLT_FB_A	C22	PR17A	2	T	RUM0_PLLT_FB_A
G19	PR8B	2	C	RUM0_PLLC_IN_A	G19	PR16B	2	C	RUM0_PLLC_IN_A
G18	PR8A	2	T	RUM0_PLLT_IN_A	G18	PR16A	2	T	RUM0_PLLT_IN_A
F20	PR7B	2	C		F20	PR15B	2	C	
F19	PR7A	2	T		F19	PR15A	2	T	
E20	PR6B	2	C		E20	PR14B	2	C	
D20	PR6A	2	T	RDQS6	D20	PR14A	2	T	RDQS14
C21	PR5B	2	C		C21	PR13B	2	C	
GND	-	-			GND	GND2	2		
C20	PR5A	2	T		C20	PR13A	2	T	
F18	PR4B	2	C		F18	PR12B	2	C	
E18	PR4A	2	T		E18	PR12A	2	T	
B22	PR3B	2	C		B22	PR11B	2	C	
B21	PR3A	2	T		B21	PR11A	2	T	
GND	-	-			GND	GND2	2		
E19	PR2B	2	C	VREF1_2	E19	PR2B	2	C	VREF1_2
D19	PR2A	2	T	VREF2_2	D19	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
GND	-	-			GND	GND1	1		
G17	PT57B	1	C		G17	PT57B	1	C	
GND	-	-			GND	GND1	1		
F17	PT57A	1	T		F17	PT57A	1	T	
D18	PT56B	1	C		D18	PT56B	1	C	
C18	PT56A	1	T		C18	PT56A	1	T	
C19	PT55B	1	C		C19	PT55B	1	C	
B20	PT55A	1	T		B20	PT55A	1	T	
D17	PT54B	1	C		D17	PT54B	1	C	
C16	PT54A	1	T	TDQS54	C16	PT54A	1	T	TDQS54
B19	PT53B	1	C		B19	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
A20	PT53A	1	T		A20	PT53A	1	T	
E17	PT52B	1	C		E17	PT52B	1	C	
C17	PT52A	1	T		C17	PT52A	1	T	
F16	PT51B	1	C		F16	PT51B	1	C	
E16	PT51A	1	T		E16	PT51A	1	T	
F15	PT50B	1	C		F15	PT50B	1	C	
D16	PT50A	1	T		D16	PT50A	1	T	
B18	PT49B	1	C		B18	PT49B	1	C	
GND	GND1	1			GND	GND1	1		
A19	PT49A	1	T		A19	PT49A	1	T	
B17	PT48B	1	C		B17	PT48B	1	C	
A18	PT48A	1	T		A18	PT48A	1	T	
B16	PT47B	1	C		B16	PT47B	1	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A5	PT13B	0	C		A5	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
A4	PT13A	0	T		A4	PT13A	0	T	
F9	PT12B	0	C		F9	PT12B	0	C	
B6	PT12A	0	T		B6	PT12A	0	T	
E9	PT11B	0	C		E9	PT11B	0	C	
C8	PT11A	0	T		C8	PT11A	0	T	
G8	PT10B	0	C		G8	PT10B	0	C	
B5	PT10A	0	T		B5	PT10A	0	T	
A3	PT9B	0	C		A3	PT9B	0	C	
GND	GND0	0			GND	GND0	0		
A2	PT9A	0	T		A2	PT9A	0	T	
F8	PT8B	0	C		F8	PT8B	0	C	
B4	PT8A	0	T		B4	PT8A	0	T	
E8	PT7B	0	C		E8	PT7B	0	C	
B3	PT7A	0	T		B3	PT7A	0	T	
D8	PT6B	0	C		D8	PT6B	0	C	
G7	PT6A	0	T	TDQS6	G7	PT6A	0	T	TDQS6
C4	PT5B	0	C		C4	PT5B	0	C	
C5	PT5A	0	T		C5	PT5A	0	T	
E7	PT4B	0	C		E7	PT4B	0	C	
D4	PT4A	0	T		D4	PT4A	0	T	
F7	PT3B	0	C		F7	PT3B	0	C	
D6	PT3A	0	T		D6	PT3A	0	T	
D7	PT2B	0	C		D7	PT2B	0	C	
E6	PT2A	0	T		E6	PT2A	0	T	
GND	GND0	0			GND	GND0	0		
K10	GND	-			K10	GND	-		
K11	GND	-			K11	GND	-		
K12	GND	-			K12	GND	-		
K13	GND	-			K13	GND	-		
K14	GND	-			K14	GND	-		
K15	GND	-			K15	GND	-		
K16	GND	-			K16	GND	-		
L10	GND	-			L10	GND	-		
L11	GND	-			L11	GND	-		
L12	GND	-			L12	GND	-		
L13	GND	-			L13	GND	-		
L14	GND	-			L14	GND	-		
L15	GND	-			L15	GND	-		
L16	GND	-			L16	GND	-		
L17	GND	-			L17	GND	-		

LatticeEC Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-4F256C	195	-4	fpBGA	256	COM	10.2K
LFEC10E-5F256C	195	-5	fpBGA	256	COM	10.2K
LFEC10E-3Q208C	147	-3	PQFP	208	COM	10.2K
LFEC10E-4Q208C	147	-4	PQFP	208	COM	10.2K
LFEC10E-5Q208C	147	-5	PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC15E-3F484C	352	-3	fpBGA	484	COM	15.3K
LFEC15E-4F484C	352	-4	fpBGA	484	COM	15.3K
LFEC15E-5F484C	352	-5	fpBGA	484	COM	15.3K
LFEC15E-3F256C	195	-3	fpBGA	256	COM	15.3K
LFEC15E-4F256C	195	-4	fpBGA	256	COM	15.3K
LFEC15E-5F256C	195	-5	fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC20E-3F672C	400	-3	fpBGA	672	COM	19.7K
LFEC20E-4F672C	400	-4	fpBGA	672	COM	19.7K
LFEC20E-5F672C	400	-5	fpBGA	672	COM	19.7K
LFEC20E-3F484C	360	-3	fpBGA	484	COM	19.7K
LFEC20E-4F484C	360	-4	fpBGA	484	COM	19.7K
LFEC20E-5F484C	360	-5	fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC33E-3F672C	496	-3	fpBGA	672	COM	32.8K
LFEC33E-4F672C	496	-4	fpBGA	672	COM	32.8K
LFEC33E-5F672C	496	-5	fpBGA	672	COM	32.8K
LFEC33E-3F484C	360	-3	fpBGA	484	COM	32.8K
LFEC33E-4F484C	360	-4	fpBGA	484	COM	32.8K
LFEC33E-5F484C	360	-5	fpBGA	484	COM	32.8K

LatticeECP Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP33E-3F484C	360	-3	fpBGA	484	COM	32.8K
LFECP33E-4F484C	360	-4	fpBGA	484	COM	32.8K
LFECP33E-5F484C	360	-5	fpBGA	484	COM	32.8K

LatticeEC Industrial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC1E-3Q208I	112	-3	PQFP	208	IND	1.5K
LFEC1E-4Q208I	112	-4	PQFP	208	IND	1.5K
LFEC1E-3T144I	97	-3	TQFP	144	IND	1.5K
LFEC1E-4T144I	97	-4	TQFP	144	IND	1.5K
LFEC1E-3T100I	67	-3	TQFP	100	IND	1.5K
LFEC1E-4T100I	67	-4	TQFP	100	IND	1.5K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC3E-3F256I	160	-3	fpBGA	256	IND	3.1K
LFEC3E-4F256I	160	-4	fpBGA	256	IND	3.1K
LFEC3E-3Q208I	145	-3	PQFP	208	IND	3.1K
LFEC3E-4Q208I	145	-4	PQFP	208	IND	3.1K
LFEC3E-3T144I	97	-3	TQFP	144	IND	3.1K
LFEC3E-4T144I	97	-4	TQFP	144	IND	3.1K
LFEC3E-3T100I	67	-3	TQFP	100	IND	3.1K
LFEC3E-4T100I	67	-4	TQFP	100	IND	3.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC6E-3F484I	224	-3	fpBGA	484	IND	6.1K
LFEC6E-4F484I	224	-4	fpBGA	484	IND	6.1K
LFEC6E-3F256I	195	-3	fpBGA	256	IND	6.1K
LFEC6E-4F256I	195	-4	fpBGA	256	IND	6.1K
LFEC6E-3Q208I	147	-3	PQFP	208	IND	6.1K
LFEC6E-4Q208I	147	-4	PQFP	208	IND	6.1K
LFEC6E-3T144I	97	-3	TQFP	144	IND	6.1K
LFEC6E-4T144I	97	-4	TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-3F484I	288	-3	fpBGA	484	IND	10.2K
LFEC10E-4F484I	288	-4	fpBGA	484	IND	10.2K
LFEC10E-3F256I	195	-3	fpBGA	256	IND	10.2K
LFEC10E-4F256I	195	-4	fpBGA	256	IND	10.2K
LFEC10E-3 P208I	147	-3	PQFP	208	IND	10.2K
LFEC10E-4 P208I	147	-4	PQFP	208	IND	10.2K

LatticeECP Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP20E-3F672I	400	-3	fpBGA	672	IND	19.7K
LFECP20E-4F672I	400	-4	fpBGA	672	IND	19.7K
LFECP20E-3F484I	360	-3	fpBGA	484	IND	19.7K
LFECP20E-4F484I	360	-4	fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP33E-3F672I	496	-3	fpBGA	672	IND	32.8K
LFECP33E-4F672I	496	-4	fpBGA	672	IND	32.8K
LFECP33E-3F484I	360	-3	fpBGA	484	IND	32.8K
LFECP33E-4F484I	360	-4	fpBGA	484	IND	32.8K

LatticeECP Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFECP33E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	32.8K
LFECP33E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	32.8K
LFECP33E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	32.8K

LatticeEC Industrial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC1E-3QN208I	112	-3	Lead-Free PQFP	208	IND	1.5K
LFEC1E-4QN208I	112	-4	Lead-Free PQFP	208	IND	1.5K
LFEC1E-3TN144I	97	-3	Lead-Free TQFP	144	IND	1.5K
LFEC1E-4TN144I	97	-4	Lead-Free TQFP	144	IND	1.5K
LFEC1E-3TN100I	67	-3	Lead-Free TQFP	100	IND	1.5K
LFEC1E-4TN100I	67	-4	Lead-Free TQFP	100	IND	1.5K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC3E-3FN256I	160	-3	Lead-Free fpBGA	256	IND	3.1K
LFEC3E-4FN256I	160	-4	Lead-Free fpBGA	256	IND	3.1K
LFEC3E-3QN208I	145	-3	Lead-Free PQFP	208	IND	3.1K
LFEC3E-4QN208I	145	-4	Lead-Free PQFP	208	IND	3.1K
LFEC3E-3TN144I	97	-3	Lead-Free TQFP	144	IND	3.1K
LFEC3E-4TN144I	97	-4	Lead-Free TQFP	144	IND	3.1K
LFEC3E-3TN100I	67	-3	Lead-Free TQFP	100	IND	3.1K
LFEC3E-4TN100I	67	-4	Lead-Free TQFP	100	IND	3.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC6E-3FN484I	224	-3	Lead-Free fpBGA	484	IND	6.1K
LFEC6E-4FN484I	224	-4	Lead-Free fpBGA	484	IND	6.1K
LFEC6E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	6.1K
LFEC6E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	6.1K
LFEC6E-3QN208I	147	-3	Lead-Free PQFP	208	IND	6.1K
LFEC6E-4QN208I	147	-4	Lead-Free PQFP	208	IND	6.1K
LFEC6E-3TN144I	97	-3	Lead-Free TQFP	144	IND	6.1K
LFEC6E-4TN144I	97	-4	Lead-Free TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC10E-3FN484I	288	-3	Lead-Free fpBGA	484	IND	10.2K
LFEC10E-4FN484I	288	-4	Lead-Free fpBGA	484	IND	10.2K
LFEC10E-3FN256I	195	-3	Lead-Free fpBGA	256	IND	10.2K
LFEC10E-4FN256I	195	-4	Lead-Free fpBGA	256	IND	10.2K
LFEC10E-3QN208I	147	-3	Lead-Free PQFP	208	IND	10.2K
LFEC10E-4QN208I	147	-4	Lead-Free PQFP	208	IND	10.2K

Date	Version	Section	Change Summary
September 2005	02.0	Architecture	sysIO section has been updated.
		DC & Switching Characteristics	Recommended Operating Conditions has been updated with V_{CCPLL}.
			DC Electrical Characteristics table has been updated
			Removed 5V Tolerant Input Buffer section.
			Register-to-Register performance table has been updated (rev. G 0.28).
			LatticeECP/EC External Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Internal Switching Characteristics table has been updated (rev. G 0.28).
			LatticeECP/EC Family Timing Adders have been updated (rev. G 0.28).
			sysCLOCK PLL timing table has been updated (rev. G 0.28)
			LatticeECP/EC sysCONFIG Port Timing specification table has been updated (rev. G 0.28).
			Master Clock table has been updated (rev. G 0.28).
			JTAG Port Timing specification table has been updated (rev. G 0.28).
		Pinout Information	Signal Description table has been updated with V_{CCPLL}.
November 2005	02.1	DC & Switching Characteristics	Pin-to-Pin Performance table has been updated (G 0.30) - 4:1MUX, 8:1MUX, 16:1MUX, 32:1MUX Register-to-Register Performance (G 0.30) - No timing number changes.
			External Switching Characteristics (G 0.30) - No timing number changes.
			Internal Switching Characteristics (G 0.30) -t_{SUP_DSP}, t_{HP_DSP}, t_{SUO_DSP}, t_{HO_DSP}, t_{COI_DSP}, t_{COD_DSP} numbers have been updated.
			Family Timing Adders (G 0.30) - No timing number changes.
			sysCLOCK PLL Timing (G 0.30) - No timing number changes.
			sysCONFIG Port Timing Specifications (G 0.30) - No timing number changes.
			Master Clock (G 0.30) - No timing number changes.
			JTAG Port Timing Specification (G 0.30) - No timing number changes.
		Ordering Information	Added 208-PQFP lead-free part numbers.
March 2006	02.2	DC & Switching Characteristics	Added footnote 3. to V_{CCAUX} in the Recommended Operating Conditions table.
January 2007	02.3	Architecture	EBR Asynchronous Reset section added.
February 2007	02.4	Architecture	Updated EBR Asynchronous Reset section.
			Updated Maximum Number of Elements in a Block table - MAC value for x9 changed to 2.
May 2007	02.5	Architecture	Updated text in Ripple Mode section.
November 2007	02.6	DC & Switching Characteristics	Added JTAG Port Waveforms diagram.
			Updated t_{RST} timing information in the sysCLOCK PLL Timing table.
		Pinout Information	Added Thermal Management text section.
		Supplemental Information	Updated title list.
February 2008	02.7	DC & Switching Characteristics	Read/Write Mode (Normal) and Read/Write Mode with Input and Output Registers waveforms in the EBR Memory Timing Diagrams section have been updated.
September 2012	02.8	All	Updated document with new corporate logo.